Unit: mm



TOSHIBA Field Effect Transistor Silicon N Channel MOS Type

## SSM3K15FU

## High Speed Switching Applications Analog Switch Applications

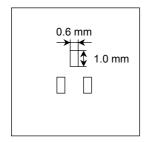
- Small package
- Low on resistance
  - :  $R_{on} = 4.0 \Omega \text{ (max) } (@V_{GS} = 4 \text{ V})$
  - :  $R_{on} = 7.0 \Omega (max) (@V_{GS} = 2.5 V)$

#### **Maximum Ratings (Ta = 25°C)**

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		$V_{DS}$	30	V	
Gate-source voltage		$V_{GSS}$	±20	٧	
Drain current	DC	I <sub>D</sub>	100	mA	
	Pulse	$I_{DP}$	200		
Drain power dissipation (Ta = 25°C)		P <sub>D</sub> (Note)	150	mW	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature		T <sub>stg</sub>	<b>−55~150</b>	°C	

Note: Mounted on FR4 board

 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ t}, \text{ Cu Pad: } 0.6 \text{ mm}^2 \times 3)$ 



# 2.1±0.1 1.25±0.1 1.25±0.1 1.0+1000 2.00+1000 1 : GATE 2 : SOURCE

3 : DRAIN

SC-70

2-2E1E

Weight: 0.006 g (typ.)

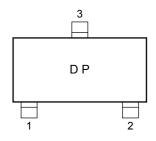
USM

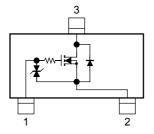
JEDEC JEITA

**TOSHIBA** 

#### Marking

#### **Equivalent Circuit**





#### **Handling Precaution**

When handling individual devices (which are not yet mounting on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

#### **Electrical Characteristics (Ta = 25°C)**

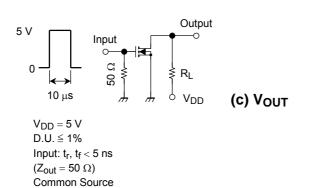
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I <sub>GSS</sub>	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$	_	_	±1	μΑ
Drain-source breakdown voltage		V (BR) DSS	$I_D = 0.1 \text{ mA}, V_{GS} = 0$	30	_	_	V
Drain cut-off currer	nt	I <sub>DSS</sub>	$V_{DS} = 30 \ V, \ V_{GS} = 0$	_	_	1	μΑ
Gate threshold volt	age	V <sub>th</sub>	$V_{DS} = 3 \text{ V}, I_D = 0.1 \text{ mA}$	0.8	_	1.5	V
Forward transfer a	dmittance	Y <sub>fs</sub>	V <sub>DS</sub> = 3 V, I <sub>D</sub> = 10 mA	25	_		mS
Drain-source ON resistance		R <sub>DS</sub> (ON)	$I_D = 10$ mA, $V_{GS} = 4$ V	_	2.2	4.0	Ω
			$I_D = 10 \text{ mA}, V_{GS} = 2.5 \text{ V}$	_	4.0	7.0	
Input capacitance		C <sub>iss</sub>	$V_{DS} = 3 V$ , $V_{GS} = 0$ , $f = 1 MHz$	_	7.8	_	pF
Reverse transfer capacitance		C <sub>rss</sub>	$V_{DS} = 3 V$ , $V_{GS} = 0$ , $f = 1 MHz$	_	3.6	_	pF
Output capacitance		Coss	$V_{DS} = 3 V$ , $V_{GS} = 0$ , $f = 1 MHz$	_	8.8	_	pF
Switching time	Turn-on time	t <sub>on</sub>	$V_{DD} = 5 \text{ V}, I_D = 10 \text{ mA}, $ $V_{GS} = 0 \sim 5 \text{ V}$	_	50	_	- ns
	Turn-off time	t <sub>off</sub>		_	180	_	

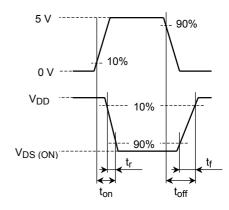
### **Switching Time Test Circuit**

 $Ta = 25^{\circ}C$ 









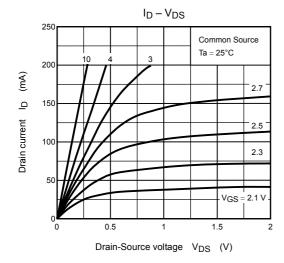
#### **Precaution**

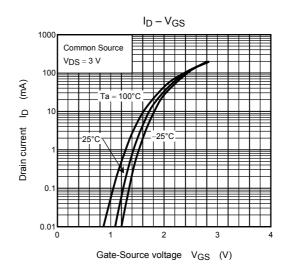
 $V_{th}$  can be expressed as voltage between gate and source when low operating current value is  $I_D$  = 100  $\mu A$  for this product. For normal switching operation,  $V_{GS}$  (on) requires higher voltage than  $V_{th}$  and  $V_{GS}$  (off) requires lower voltage than  $V_{th}$ .

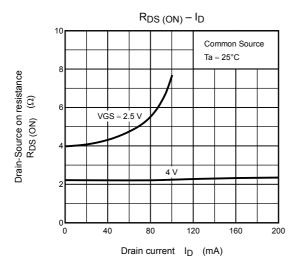
(relationship can be established as follows:  $V_{GS (off)} < V_{th} < V_{GS (on)}$ )

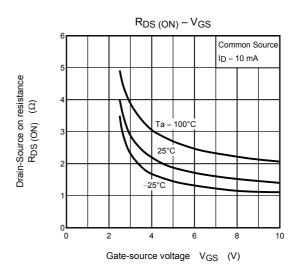
Please take this into consideration for using the device.

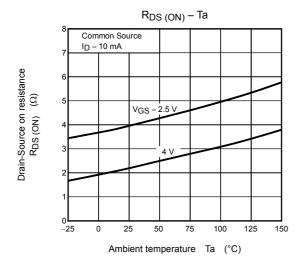
 $V_{\rm GS}$  recommended voltage of 2.5 V or higher to turn on this product.

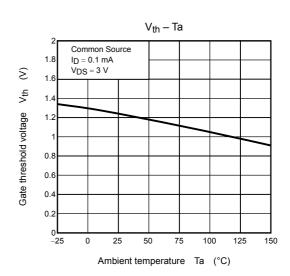


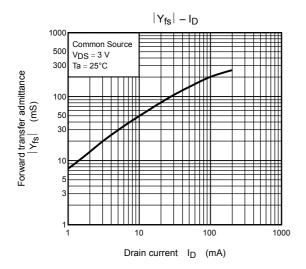


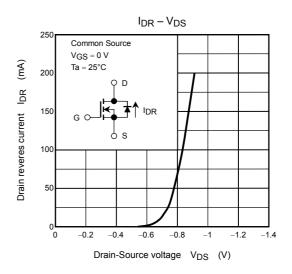


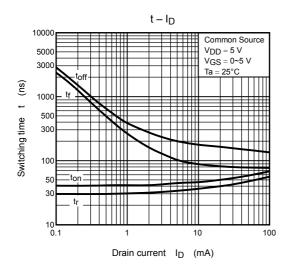


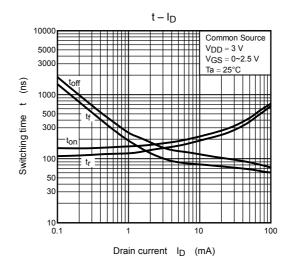


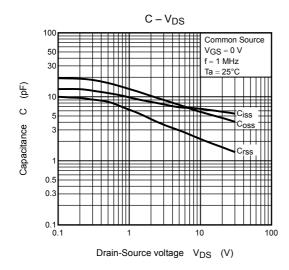


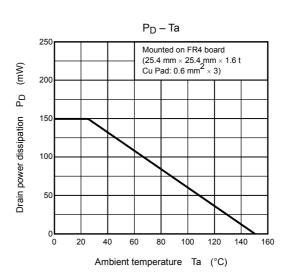












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